

Product Summary

V _{RRM}	(V)	l _o (mA)	V _F Max (V) @ +25°C	I _R Max (μA) @ +25°C
30		200	0.50	9

Description

The SDM02U30CSP is a 30-Volt 0.2A Schottky Barrier Diode that is optimized for low forward voltage drop and low leakage current. It's housed in a compact Chip Scale Package (CSP) that occupies only 0.18mm² board space. The low thermal resistance enables designers to meet design challenges of increasing efficiency while reducing board space. It is ideally suited for use in portable applications.

Applications

- Blocking Diode
- Reverse Protection Diode
- Boost Diode

Features and Benefits

- 0.18mm² Footprint, Off Board Profile of 0.28mm
- Low Forward Voltage of 0.50V (Max) Minimizes Power Dissipation Losses
- Low Leakage Maximizes Battery Power
- Soft, Fast Switching Capability
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data Case: X3-WLB0603-2

- Moisture Sensitivity: Level 1 per J-STD-020
- Polarity Indicator: Cathode Dot
- Terminals: NiAu Bump. Solderable per MIL-STD-202, Method 208 @
- Weight: 0.1mg (Approximate)

X3-WLB0603-2



Top View



Bottom View

Ordering Information (Note 4)

Part Number	Case	Packaging
SDM02U30CSP-7	X3-WLB0603-2	10,000/Tape & Reel

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

 See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information

Notes:

X3-WLB0603-2



K = Product Type Marking Code Dot Denotes Cathode Pin



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitance load, derate current by 20%. Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V _{RRM}	30	V
Average Rectified Output Current	lo	0.2	А
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	IFSM	4.5	A

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance Junction to Ambient (Note 5)	R _{0JA}	215	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

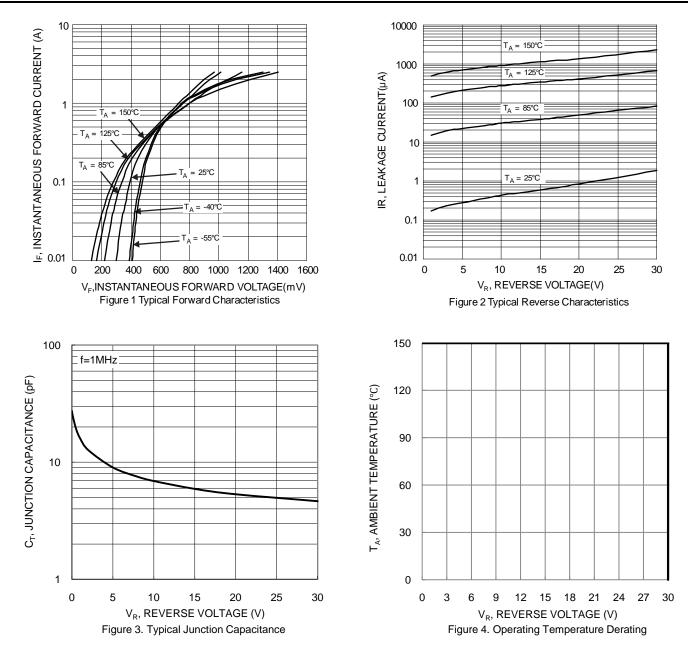
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
	VF		0.24	0.29	V	I _F = 1mA, T _J = +25°C
		-	0.30	0.34		I _F = 10mA, T _J = +25°C
Forward Voltage Drop		-	0.40	0.46		I _F = 100mA, T _J = +25°C
		-	0.45	0.50		I _F = 200mA, T _J = +25°C
		-	0.39	—		I _F = 200mA, T _J = +125°C
	(Note 6) I _R	-	0.4	2.0	μA	$V_{R} = 10V, T_{J} = +25^{\circ}C$
Leakage Current (Note 6)		-	1.5	9	μA	$V_{R} = 30V, T_{J} = +25^{\circ}C$
		-	0.7	—	mA	$V_R = 30V, T_J = +125^{\circ}C$
Junction Capacitance	CT		7	_	pF	$V_R = 10V, T_J = +25^{\circ}C$, f = 1MHz

Notes: 5. Device mounted on FR-4 substrate PC board, with minimum recommended pad layout per http://www.diodes.com/package-outlines.html. 6. Short duration pulse test used to minimize self-heating effect.



Typical Electrical Characteristics

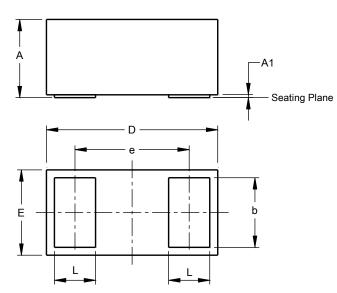




Package Outline Dimensions (Note 7)

Please see http://www.diodes.com/package-outlines.html for the latest version.

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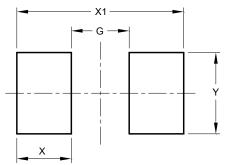
X3-WLB0603-2					
Dim	Min	Max	Тур		
Α	0.250	0.300	0.275		
A1	0.00	0.01	_		
b	0.220	0.280	0.245		
D	0.575	0.625	0.600		
Е	0.275	0.325	0.300		
е	-	_	0.400		
L	0.120	0.180	0.144		
All Dimensions in mm					

Note 7: Device side walls are electrically active bare silicon. Avoid contact of solder or flux on the side walls during the PCB assembly process.

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

X3-WLB0603-2



Dimensions	Value (in mm)	
G	0.206	
Х	0.194	
Y	0.291	
X1	0.594	



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